

# Phase Control Thyristors (Hockey PUK Version), 720 A



TO-200AB (E-PUK)

PRODUCT SUMMARY				
Package	TO-200AB (E-PUK)			
Diode variation	Single SCR			
I <sub>T(AV)</sub>	720 A			
V <sub>DRM</sub> /V <sub>RRM</sub>	400 V, 800 V, 1200 V, 1400 V, 1600 V			
V <sub>TM</sub>	1.96 V			
I <sub>GT</sub>	100 mA			
T <sub>J</sub>	-40 °C to 125 °C			

#### **FEATURES**

- · Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AB (E-PUK)



- Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **TYPICAL APPLICATIONS**

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES	UNITS			
		720	A			
I <sub>T(AV)</sub>	T <sub>hs</sub>	55	°C			
ı		1420	A			
I <sub>T(RMS)</sub>	T <sub>hs</sub>	25	°C			
ı	50 Hz	9000	A			
I <sub>TSM</sub>	60 Hz	9420	^			
l <sup>2</sup> t	50 Hz	405	kA <sup>2</sup> s			
I-ι	60 Hz	370	KA-S			
V <sub>DRM</sub> /V <sub>RRM</sub>		400 to 1600	V			
t <sub>q</sub>	Typical	100	μs			
T <sub>J</sub>		-40 to 125	°C			

#### **ELECTRICAL SPECIFICATIONS**

VOLTAGE RA	ATINGS			
TYPE NUMBER	VOLTAGE CODE	V <sub>DRM</sub> /V <sub>RRM</sub> , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	$\begin{aligned} I_{DRM}/I_{RRM} & \text{MAXIMUM} \\ & \text{AT T}_{J} = \text{T}_{J} \\ & \text{MAXIMUM mA} \end{aligned}$
	04	400	500	
	08	800	900	
VS-ST330CC	12	1200	1300	50
	14	1400	1500	
	16	1600	1700	



ABSOLUTE MAXIMUM RATINGS	3						
PARAMETER	SYMBOL		VALUES	UNITS			
Maximum average on-state current		180° condu	180° conduction, half sine wave			Α	
at heatsink temperature	I <sub>T(AV)</sub>	double side	(single side) co	oled	55 (75)	°C	
Maximum RMS on-state current	I <sub>T(RMS)</sub>	DC at 25 °C	heatsink tempe	erature double side cooled	1420		
		t = 10 ms	No voltage		9000		
Maximum peak, one-cycle		t = 8.3 ms	reapplied		9420	A kA <sup>2</sup> s	
non-repetitive surge current	I <sub>TSM</sub>	t = 10 ms	100 % V <sub>RRM</sub>		7570		
		t = 8.3 ms	reapplied	Sinusoidal half wave,	7920		
	l <sup>2</sup> t	t = 10 ms	No voltage reapplied	initial $T_J = T_J$ maximum	405		
Marrian II San Errian		t = 8.3 ms			370		
Maximum I <sup>2</sup> t for fusing		t = 10 ms			287		
		t = 8.3 ms	reapplied		262		
Maximum I <sup>2</sup> √t for fusing	I²√t	t = 0.1 to 10	t = 0.1 to 10 ms, no voltage reapplied			kA²√s	
Low level value of threshold voltage	V <sub>T(TO)1</sub>	(16.7 % x π	$x I_{T(AV)} < I < \pi x$	$I_{T(AV)}$ ), $T_J = T_J$ maximum	0.91	V	
High level value of threshold voltage	V <sub>T(TO)2</sub>	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			0.92	\ \ \	
Low level value of on-state slope resistance	r <sub>t1</sub>	(16.7 % x π	(16.7 % x $\pi$ x $I_{T(AV)} < I < \pi$ x $I_{T(AV)}$ ), $T_J = T_J$ maximum			mΩ	
High level value of on-state slope resistance	r <sub>t2</sub>	$(I > \pi \times I_{T(AV)})$ , $T_J = T_J$ maximum			0.57	11152	
Maximum on-state voltage	$V_{TM}$	I <sub>pk</sub> = 1810 A	$I_{pk} = 1810 \text{ A}, T_J = T_J \text{ maximum}, t_p = 10 \text{ ms sine pulse}$			V	
Maximum holding current	I <sub>H</sub>	T _ 05 °C	T <sub>.1</sub> = 25 °C, anode supply 12 V resistive load			mΛ	
Typical latching current	ΙL	] IJ = 25 C,	anoue supply i	Z v resistive ioda	1000	mA	

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of turned-on current	dI/dt	Gate drive 20 V, 20 $\Omega$ , $t_r \le 1~\mu s$ $T_J = T_J$ maximum, anode voltage $\le 80~\%~V_{DRM}$	1000	A/μs
Typical delay time	t <sub>d</sub>	Gate current 1 A, $dl_g/dt = 1 A/\mu s$ $V_d = 0.67 \% V_{DRM}, T_J = 25 °C$	1.0	
Typical turn-off time	t <sub>q</sub>	$I_{TM}$ = 550 A, $T_J$ = $T_J$ maximum, dl/dt = 40 A/μs, $V_R$ = 50 V, dV/dt = 20 V/μs, gate 0 V 100 $\Omega$ , $t_p$ = 500 μs	100	μs

BLOCKING							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum critical rate of rise of off-state voltage	dV/dt	T <sub>J</sub> = T <sub>J</sub> maximum linear to 80 % rated V <sub>DRM</sub>	500	V/µs			
Maximum peak reverse and off-state leakage current	I <sub>RRM</sub> , I <sub>DRM</sub>	$T_J = T_J$ maximum, rated $V_{DRM}/V_{RRM}$ applied	50	mA			



TRIGGERING								
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES			
PANAMETER	PARAMETER STMBOL		TEST CONDITIONS			UNITS		
Maximum peak gate power	P <sub>GM</sub>	$T_J = T_J$ maximum,	$t_p \le 5 \text{ ms}$	10.0		W		
Maximum average gate power	P <sub>G(AV)</sub>	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	2	.0	l vv		
Maximum peak positive gate current	I <sub>GM</sub>	$T_J = T_J$ maximum,	$t_p \le 5 \text{ ms}$	3	.0	Α		
Maximum peak positive gate voltage	+ V <sub>GM</sub>	T - T maximum	+ < 5 ma	20		V		
Maximum peak negative gate voltage	- V <sub>GM</sub>	$T_J = T_J$ maximum,	l <sub>p</sub> ≤ 3 ms	5.0				
DC gate current required to trigger		T <sub>J</sub> = -40 °C	Maximum required gate trigger/ current/voltage are the lowest value which will trigger all units	200	-	mA V		
	I <sub>GT</sub>	T <sub>J</sub> = 25 °C		100	200			
		T <sub>J</sub> = 125 °C		50	-			
	V <sub>GT</sub>	T <sub>J</sub> = -40 °C		2.5	-			
DC gate voltage required to trigger		T <sub>J</sub> = 25 °C	12 V anode to cathode applied	1.8	3.0			
		T <sub>J</sub> = 125 °C		1.1	-			
DC gate current not to trigger	I <sub>GD</sub>	T T manyimay	Maximum gate current/voltage not to trigger is the maximum	10		mA		
DC gate voltage not to trigger	V <sub>GD</sub>	$T_J = T_J$ maximum value which will not trigger any unit with rated $V_{DRM}$ anode to cathode applied		0.25		٧		

THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum operating junction temperature range	$T_J$		-40 to 125	ڻ ئ			
Maximum storage temperature range	T <sub>Stg</sub>		-40 to 150				
Maximum thermal resistance, junction to heatsink	D	DC operation single side cooled	0.09				
waximum thermal resistance, junction to heatsink	R <sub>thJ-hs</sub>	DC operation double side cooled	0.04	K/W			
Maximum thermal resistance, case to heatsink	R <sub>thC-hs</sub>	DC operation single side cooled	0.02	IV.			
waximum thermal resistance, case to heatslink		DC operation double side cooled	0.01				
Mounting force, ± 10 %			9800	N			
Wodriting force, ± 10 /0			(1000)	(kg)			
Approximate weight			83	g			
Case style		See dimensions - link at the end of datasheet	TO-200AB (E	E-PUK)			

ΔR <sub>thJ-hs</sub> CONDUCTION								
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION		RECTANGULAR	R CONDUCTION	TECT COMPITIONS	LINITE		
CONDUCTION ANGLE	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE	TEST CONDITIONS	UNITS		
180°	0.012	0.011	0.008	0.007				
120°	0.014	0.012	0.014	0.013	T <sub>J</sub> = T <sub>J</sub> maximum			
90°	0.017	0.015	0.019	0.017		K/W		
60°	0.025	0.022	0.026	0.023				
30°	0.043	0.036	0.043	0.037				

#### Note

• The table above shows the increment of thermal resistance R<sub>thJ-hs</sub> when devices operate at different conduction angles than DC

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# Vishay Semiconductors

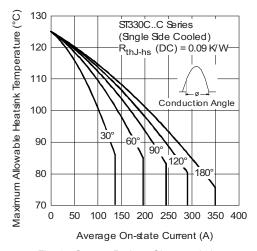


Fig. 1 - Current Ratings Characteristics

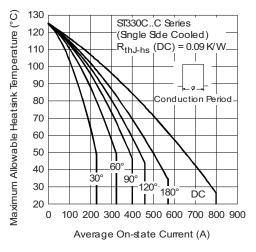
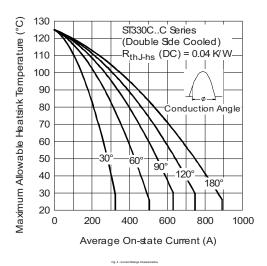


Fig. 2 - Current Ratings Characteristics



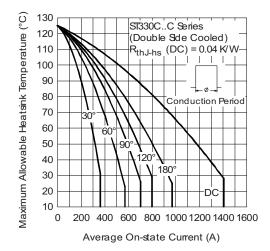


Fig. 4 - Current Ratings Characteristics

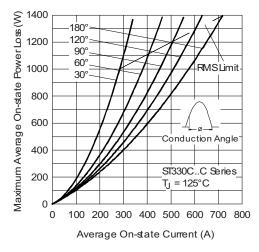


Fig. 5 - On-State Power Loss Characteristics

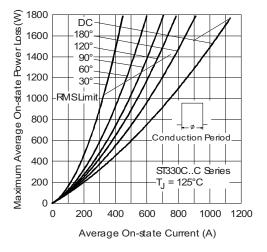


Fig. 6 - On-State Power Loss Characteristics

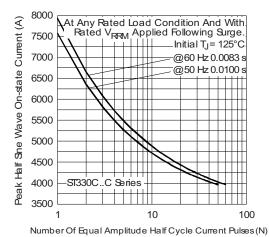


Fig. 7 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

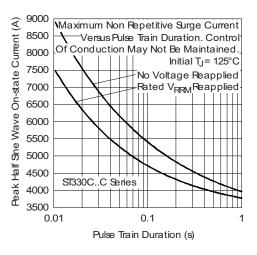


Fig. 8 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

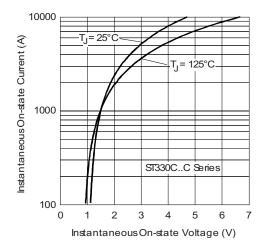


Fig. 9 - On-State Voltage Drop Characteristics

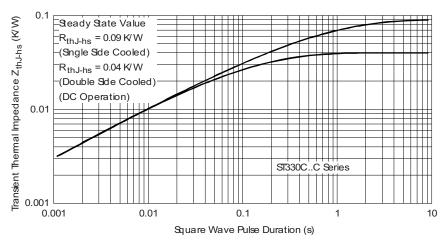


Fig. 10 - Thermal Impedance Z<sub>thJ-hs</sub> Characteristics

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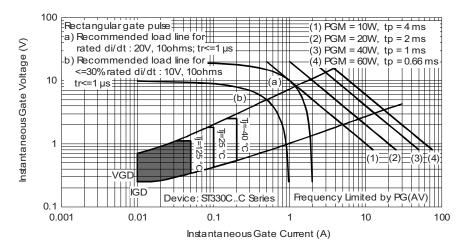


Fig. 11 - Gate Characteristics

#### **ORDERING INFORMATION TABLE**

**Device code** VS-ST 33 0 C C 1 16 7 2 (3) 4 5 (6 8 Vishay Semiconductors product **Thyristor** Essential part number 0 = Converter grade C = Ceramic PUK Voltage code x 100 = V<sub>RRM</sub> (see Voltage Ratings table) C = PUK case TO-200AB (E-PUK) 0 = Eyelet terminals (gate and auxiliary cathode unsoldered leads) 1 = Fast-on terminals (gate and auxiliary cathode unsoldered leads)

2 = Eyelet terminals (gate and auxiliary cathode soldered leads)
3 = Fast-on terminals (gate and auxiliary cathode soldered leads)

Critical dV/dt: • None = 500 V/us (standard selection)

9 - Critical dV/dt: • None = 500 V/µs (standard selection)
• L = 1000 V/µs (special selection)

LINKS TO RELATED DOCUMENTS

Dimensions http://www.vishav.com/doc?95075

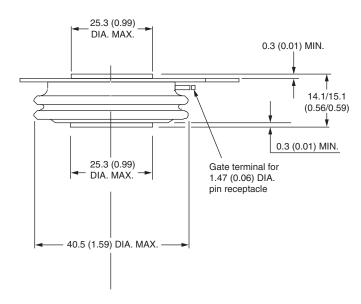


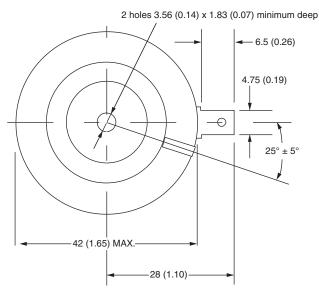
# **TO-200AB (E-PUK)**

#### **DIMENSIONS** in millimeters (inches)

Anode to gate

Creepage distance: 11.18 (0.44) minimum Strike distance: 7.62 (0.30) minimum





Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)



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